

## Features

- 90%+ Efficiency
- Internal Short-Circuit Protection
- Pin-Compatible with 3-Terminal Linear Regulators
- Laser-Trimmed Output Voltage
- Over-Temperature Protection
- Small Footprint
- Wide Input Range
- 5-Pin Mount Option (Suffixes L & M)

## Description

The PT5100 modules are a series of economical, easy-to-use 1-A positive step-down, Integrated Switching Regulators (ISRs). These ISRs are compatible with most TO-220 style linear regulators, and when employed as a linear replacement, provide significant benefits in both efficiency and power dissipation. They are recommended for use in a wide variety of on-board power regulation applications. These include computer, data storage, industrial controls, and battery powered equipment. Modules are laser-trimmed for optimal output voltage accuracy, and exhibit excellent line and load regulation. The PT5100 also features output current limiting and thermal shutdown protection.

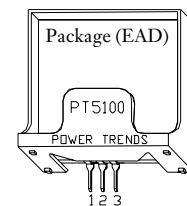
## Ordering Information

<b>PT5101</b> □	= +5.0 Volts
<b>PT5102</b> □	= +12.0 Volts
<b>PT5103</b> □	= +3.3 Volts
<b>PT5105</b> □	= +6.5 Volts
<b>PT5107</b> □	= +15.0 Volts
<b>PT5109</b> □	= +5.6 Volts
<b>PT5110</b> □	= +9.0 Volts
<b>PT5111</b> □	= +10.0 Volts
<b>PT5112</b> □	= +8.0 Volts

## PT Series Suffix (PT1234x)

Case/Pin Configuration	Order Suffix	Package Code
Vertical	<b>N</b>	(EAD)
Horizontal	<b>A</b>	(EAA)
SMD	<b>C</b>	(EAC)
Horizontal, 2-pin Tab	<b>M</b>	(EAM)
SMD, 2-Pin Tab	<b>L</b>	(EAL)

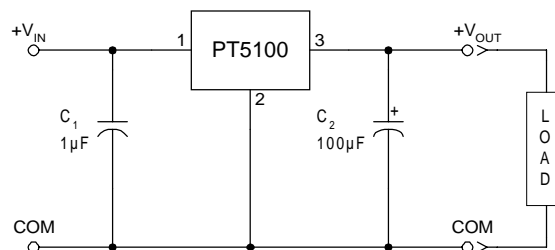
(Reference the applicable package code drawing for the dimensions and PC board layout)



## Pin-Out Information

Pin	Function
1	V <sub>in</sub>
2	GND
3	V <sub>out</sub>

## Standard Application



C<sub>1</sub> = Optional 1μF ceramic capacitor  
C<sub>2</sub> = Required 100μF electrolytic

**Specifications** (Unless otherwise stated,  $T_a = 25^\circ\text{C}$ ,  $V_{in} = V_{inmin}$ ,  $C_{out} = 100\mu\text{F}$ , and  $I_o = I_{o\max}$ )

Characteristic	Symbol	Conditions	PT5100 SERIES			Units
			Min	Typ	Max	
Output Current	$I_o$	Over $V_{in}$ range	0.1 <sup>(1)</sup>	—	1.0	A
Input Voltage Range	$V_{in}$	Over $I_o$ Range $V_o = 3.3\text{V}$ $V_o = 5.0\text{V}$ $V_o > 5.0\text{V}$	9 9 $V_o + 4$	— — —	26 38 38	VDC
Set Point Voltage Tolerance	$V_o \text{ tol}$		—	$\pm 1$	$\pm 2$	% $V_o$
Temperature Variation	$\text{Reg}_{\text{temp}}$	$0^\circ \leq T_a \leq +60^\circ\text{C}$ , $I_o = I_{o\min}$	—	$\pm 0.5$	—	% $V_o$
Line Regulation	$\text{Reg}_{\text{line}}$	Over $V_{in}$ range	—	$\pm 5$	$\pm 10$	mV
Load Regulation	$\text{Reg}_{\text{load}}$	Over $I_o$ range	—	$\pm 5$	$\pm 10$	mV
Total Output Voltage Variation	$\Delta V_{o\text{tot}}$	Includes set-point, line, load, $0^\circ \leq T_a \leq +60^\circ\text{C}$	—	$\pm 1.5$	$\pm 3$	% $V_o$
Efficiency	$\eta$	$V_o = 15\text{V}$ $V_o = 12\text{V}$ $V_o = 10\text{V}$ $V_o = 5.0\text{V}$ $V_o = 3.3\text{V}$	— — — — —	95 94 92 90 82	— — — — —	%
$V_o$ Ripple (pk-pk)	$V_r$	20MHz bandwidth	—	2	—	% $V_o$
Transient Response	$t_{tr}$	1A/ $\mu\text{s}$ load step, 50% to 100% $I_{o\max}$	—	100	200	$\mu\text{s}$
	$\Delta V_{tr}$	$V_o$ over/undershoot	—	$\pm 5.0$	—	% $V_o$
Current Limit	$I_{lim}$	$\Delta V_o = -1\%$	1.2	2.6	—	A
Switching Frequency	$f_s$	Over $V_{in}$ range $V_o \geq 5.0\text{V}$ $V_o \leq 3.3\text{V}$	500 575	650 725	800 875	kHz
External Output Capacitance	$C_{out}$		100	—	—	$\mu\text{F}$
Operating Temperature Range	$T_a$	Over $V_{in}$ range	$-40$ <sup>(2)</sup>	—	$+85$ <sup>(3)</sup>	$^\circ\text{C}$
Thermal Resistance	$\theta_{ja}$	Free-air convection (40-60LFM) $V_o = 3.3\text{V}$ $V_o = 5.0\text{V}$ $V_o \geq 12\text{V}$	— — —	45 50 60	— — —	$^\circ\text{C/W}$
Storage Temperature	$T_s$	—	$-40$	—	$+125$	$^\circ\text{C}$
Reliability	MTBF	Per Bellcore TR-332 50% stress, $T_a = 40^\circ\text{C}$ , ground benign	11.3	—	—	$10^6$ Hrs
Mechanical Shock	—	Per Mil-Std-883D, method 2002.3, 1mS, half-sine, mounted to a fixture	—	500	—	G's
Mechanical Vibration	—	Per Mil-Std-883D, Method 2007.2 20-2000Hz, soldered in PC board	—	5 <sup>(4)</sup>	—	G's
Weight	—	Suffixes N, A, & C Suffixes L & M	— —	4.5 6.5	— —	grams
Flammability	—	Materials meet UL 94V-0	—	—	—	—

**Notes:** (1) The ISR will operate at no load with reduced specifications.(2) For operation below  $0^\circ\text{C}$ , use a tantalum type capacitor for  $C_2$ .

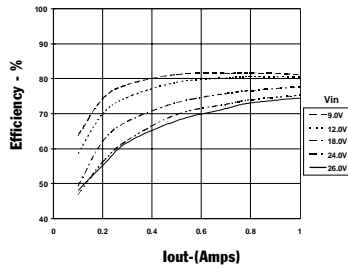
(3) See Thermal Derating curves.

(4) The tab pins on the 5-pin mount package types (suffixes L &amp; M) must be soldered. For more information see the applicable package outline drawing.

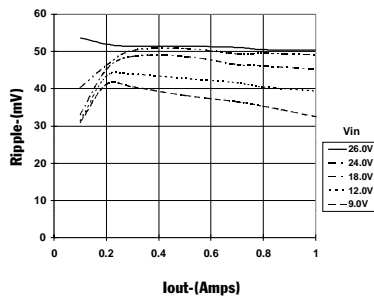
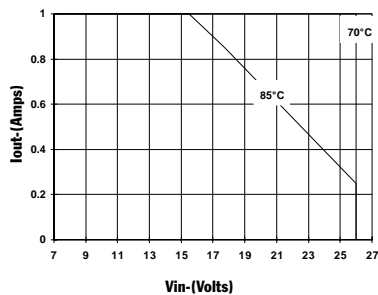
1-A Positive Step-down  
Integrated Switching Regulator

PT5103, 3.3 VDC (See Note A)

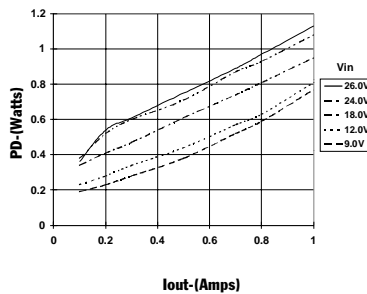
Efficiency vs Output Current



Ripple vs Output Current

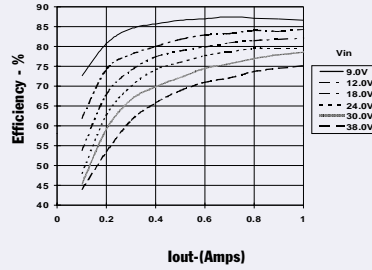
Thermal Derating ( $T_A$ ) (See Note B)

Power Dissipation vs Output Current

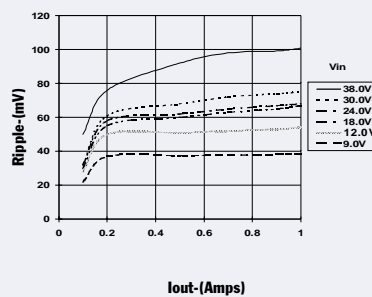
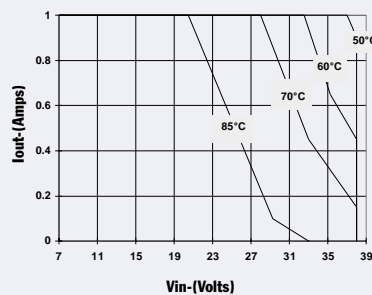


PT5101, 5.0 VDC (See Note A)

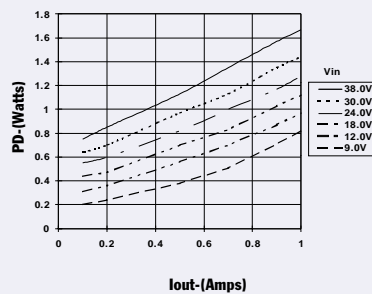
Efficiency vs Output Current



Ripple vs Output Current

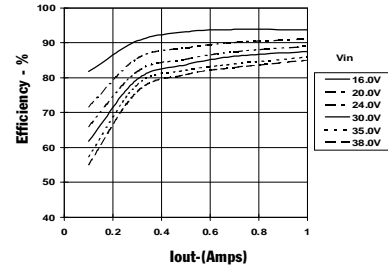
Thermal Derating ( $T_A$ ) (See Note B)

Power Dissipation vs Output Current

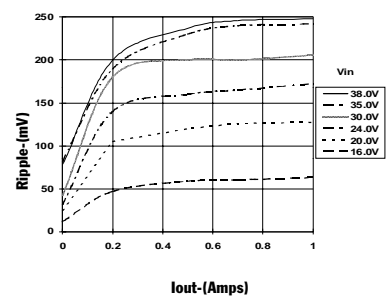
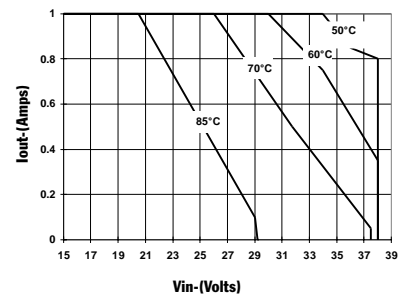


PT5102, 12.0 VDC (See Note A)

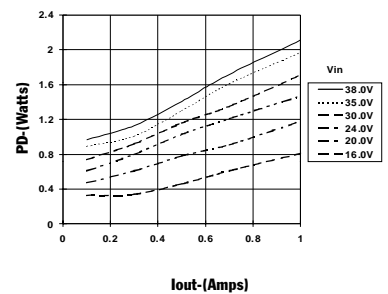
Efficiency vs Output Current



Ripple vs Output Current

Thermal Derating ( $T_A$ ) (See Note B)

Power Dissipation vs Output Current



**Note A:** Characteristic data has been developed from actual products tested at 25°C. This data is considered typical data for the Converter.

**Note B:** Thermal derating graphs are developed in free-air convection cooling, which corresponds to approximately 40–60LFM of airflow.

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
PT5101A	ACTIVE	SIP MOD ULE	EAA	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5101C	ACTIVE	SIP MOD ULE	EAC	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5101CT	ACTIVE	SIP MOD ULE	EAC	3	200	TBD	Call TI	Level-1-215C-UNLIM
PT5101G	ACTIVE	SIP MOD ULE	EAG	3	16	TBD	Call TI	Level-1-215C-UNLIM
PT5101H	ACTIVE	SIP MOD ULE	EAH	3	16	TBD	Call TI	Level-1-215C-UNLIM
PT5101J	ACTIVE	SIP MOD ULE	EAJ	3	16	TBD	Call TI	Level-1-215C-UNLIM
PT5101L	ACTIVE	SIP MOD ULE	EAL	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5101M	ACTIVE	SIP MOD ULE	EAM	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5101N	ACTIVE	SIP MOD ULE	EAD	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5101S	ACTIVE	SIP MOD ULE	EAF	3	16	TBD	Call TI	Level-1-215C-UNLIM
PT5101U	ACTIVE	SIP MOD ULE	EAU	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5102A	ACTIVE	SIP MOD ULE	EAA	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5102C	ACTIVE	SIP MOD ULE	EAC	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5102CT	ACTIVE	SIP MOD ULE	EAC	3	200	TBD	Call TI	Level-1-215C-UNLIM
PT5102H	ACTIVE	SIP MOD ULE	EAH	3	16	TBD	Call TI	Level-1-215C-UNLIM
PT5102J	ACTIVE	SIP MOD ULE	EAJ	3	16	TBD	Call TI	Level-1-215C-UNLIM
PT5102M	ACTIVE	SIP MOD ULE	EAM	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5102N	ACTIVE	SIP MOD ULE	EAD	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5102S	ACTIVE	SIP MOD ULE	EAF	3	16	TBD	Call TI	Level-1-215C-UNLIM
PT5103A	ACTIVE	SIP MOD ULE	EAA	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5103C	ACTIVE	SIP MOD ULE	EAC	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5103H	ACTIVE	SIP MOD ULE	EAH	3	16	TBD	Call TI	Level-1-215C-UNLIM
PT5103J	ACTIVE	SIP MOD ULE	EAJ	3	16	TBD	Call TI	Level-1-215C-UNLIM
PT5103L	ACTIVE	SIP MOD ULE	EAL	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5103M	ACTIVE	SIP MOD ULE	EAM	3	35	TBD	Call TI	Level-1-215C-UNLIM

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
PT5103N	ACTIVE	SIP MOD ULE	EAD	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5105A	ACTIVE	SIP MOD ULE	EAA	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5105C	ACTIVE	SIP MOD ULE	EAC	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5105L	ACTIVE	SIP MOD ULE	EAL	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5105N	ACTIVE	SIP MOD ULE	EAD	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5107A	ACTIVE	SIP MOD ULE	EAA	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5107C	ACTIVE	SIP MOD ULE	EAC	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5107J	ACTIVE	SIP MOD ULE	EAJ	3	16	TBD	Call TI	Level-1-215C-UNLIM
PT5107M	ACTIVE	SIP MOD ULE	EAM	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5107N	ACTIVE	SIP MOD ULE	EAD	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5109A	ACTIVE	SIP MOD ULE	EAA	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5109C	ACTIVE	SIP MOD ULE	EAC	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5109M	ACTIVE	SIP MOD ULE	EAM	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5109N	ACTIVE	SIP MOD ULE	EAD	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5110A	ACTIVE	SIP MOD ULE	EAA	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5110C	ACTIVE	SIP MOD ULE	EAC	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5110N	ACTIVE	SIP MOD ULE	EAD	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5110S	ACTIVE	SIP MOD ULE	EAF	3	16	TBD	Call TI	Level-1-215C-UNLIM
PT5111A	ACTIVE	SIP MOD ULE	EAA	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5111C	ACTIVE	SIP MOD ULE	EAC	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5111M	ACTIVE	SIP MOD ULE	EAM	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5111N	ACTIVE	SIP MOD ULE	EAD	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5112A	ACTIVE	SIP MOD ULE	EAA	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5112C	ACTIVE	SIP MOD ULE	EAC	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5112L	ACTIVE	SIP MOD ULE	EAL	3	35	TBD	Call TI	Level-1-215C-UNLIM
PT5112N	ACTIVE	SIP MOD ULE	EAD	3	35	TBD	Call TI	Level-1-215C-UNLIM

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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